# Dual Series Schottky Barrier Diodes

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.

### Features

- Extremely Fast Switching Speed
- Low Forward Voltage 0.35 Volts (Typ) @  $I_F = 10 \text{ mAdc}$
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

**MAXIMUM RATINGS** (T<sub>J</sub> =  $125^{\circ}C$  unless otherwise noted)

Rating	Symbol	Value	Unit	
Reverse Voltage	V <sub>R</sub>	30	V	
Forward Power Dissipation @ $T_A = 25^{\circ}C$ Derate above 25°C	P <sub>F</sub>	225 1.8	mW mW/°C	
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\thetaJA}$	555	°C/W	
Forward Current (DC)	١ <sub>F</sub>	200 Max	mA	
Non–Repetitive Peak Forward Current, $t_p < 10$ msec	I <sub>FSM</sub>	600	mA	
Repetitive Peak Forward Current Pulse Wave = 1 sec, Duty Cycle = 66%	I <sub>FRM</sub>	300	mA	
Junction Temperature	Τ <sub>J</sub>	-55 to 125	°C	
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

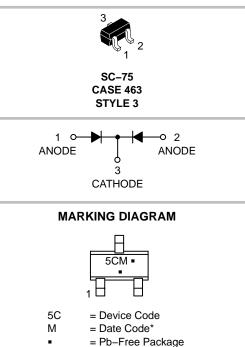
1. FR-4 board with minimum mounting pad.



# **ON Semiconductor®**

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# 30 VOLT DUAL COMMON CATHODE SCHOTTKY BARRIER DIODES



(Note: Microdot may be in either location)

\*Date Code orientation may vary depending up-

on manufacturing location.

#### ORDERING INFORMATION

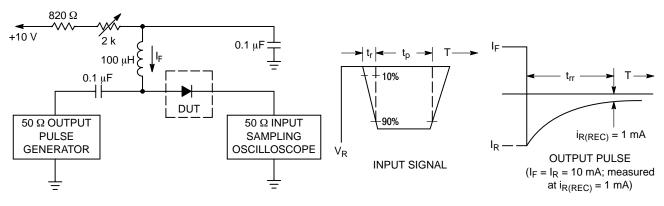
	Device	Package	Shipping <sup>†</sup>
BAT5	4CTT1G	SC-75 (Pb-Free)	3,000 / Tape & Reel
SBAT	54CTT1G	SC-75 (Pb-Free)	3,000 / Tape & Reel

<sup>+</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# BAT54CT

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage $(I_R = 10 \ \mu A)$	V <sub>(BR)R</sub>	30	-	-	V
Total Capacitance ( $V_R = 1.0 V, f = 1.0 MHz$ )	CT	_	7.6	10	pF
Reverse Leakage $(V_R = 25 V)$	۱ <sub>R</sub>	_	0.5	2.0	μAdc
Forward Voltage $(I_F = 0.1 \text{ mA})$ $(I_F = 1.0 \text{ mA})$ $(I_F = 10 \text{ mA})$ $(I_F = 30 \text{ mA})$ $(I_F = 100 \text{ mA})$	VF	- - - -	0.22 0.29 0.35 0.41 0.52	0.24 0.32 0.40 0.50 0.80	V
Reverse Recovery Time ( $I_F = I_R = 10 \text{ mAdc}, I_{R(REC)} = 1.0 \text{ mAdc}, Figure 1$ )	t <sub>rr</sub>	_	_	5.0	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



Notes: 1. A 2.0 k $\Omega$  variable resistor adjusted for a Forward Current (I<sub>F</sub>) of 10 mA. 2. Input pulse is adjusted so I<sub>R(peak)</sub> is equal to 10 mA.

3. t<sub>p</sub> » t<sub>rr</sub>

#### Figure 1. Recovery Time Equivalent Test Circuit

# BAT54CT

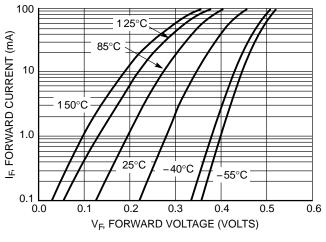


Figure 2. Forward Voltage

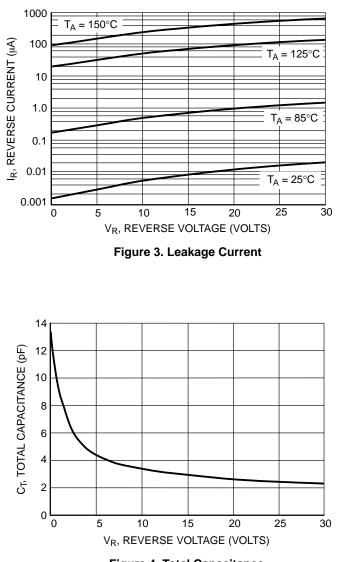


Figure 4. Total Capacitance





\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

1.000

0.039

SCALE 10:1

mm

inches

0.508

0.020

 
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 PAGE 1 OF 1

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